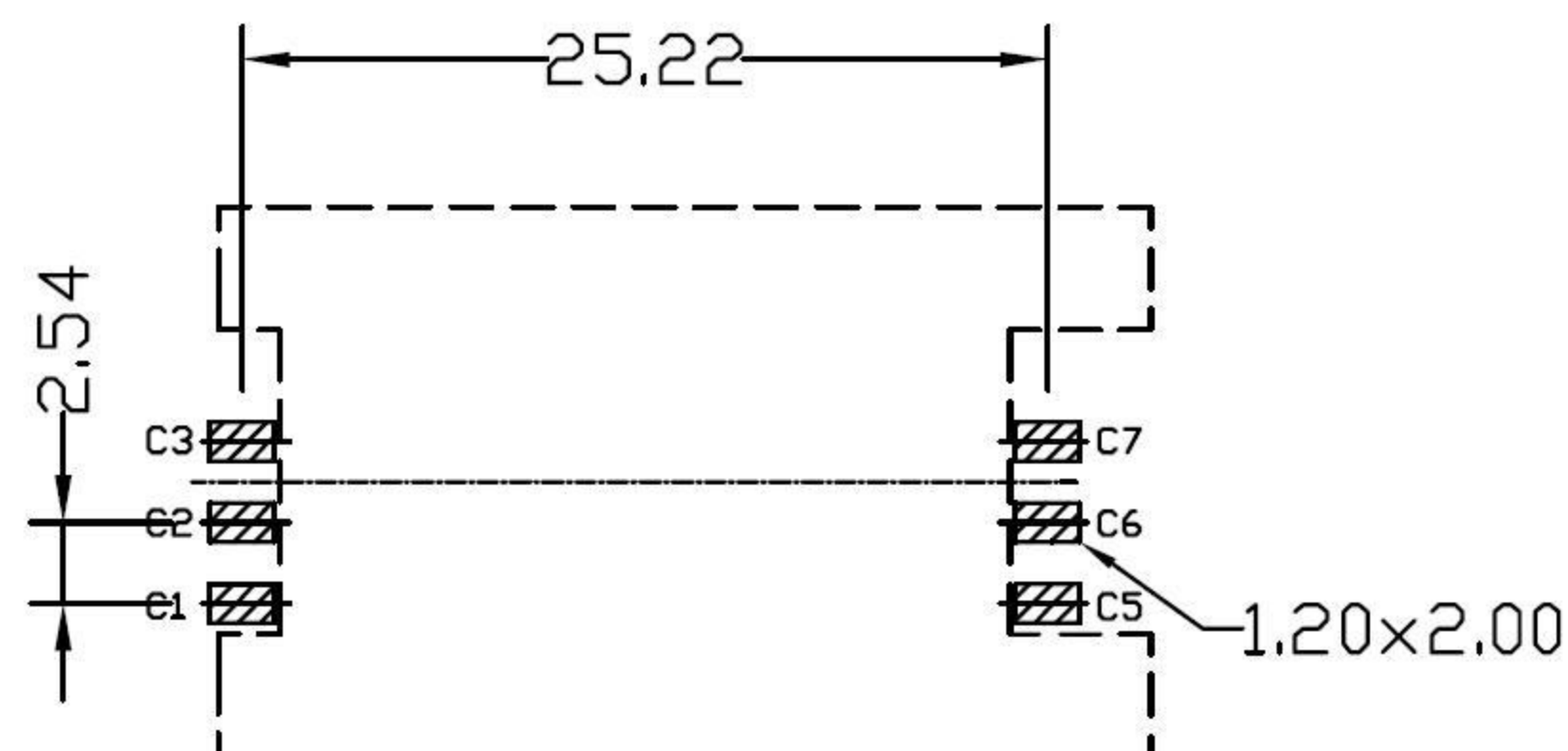
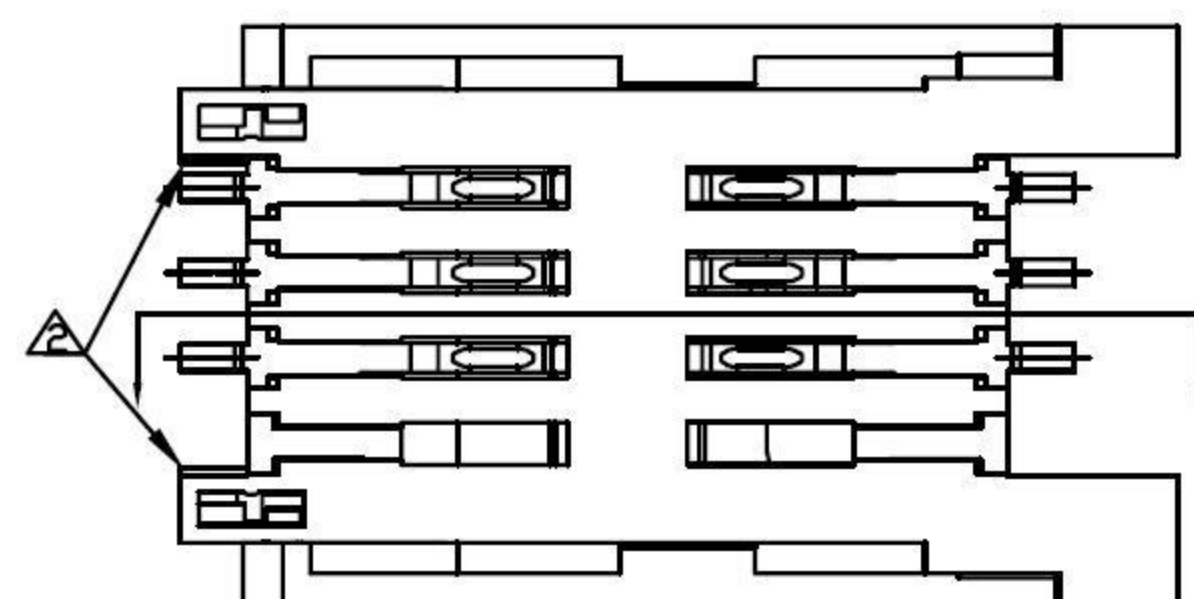
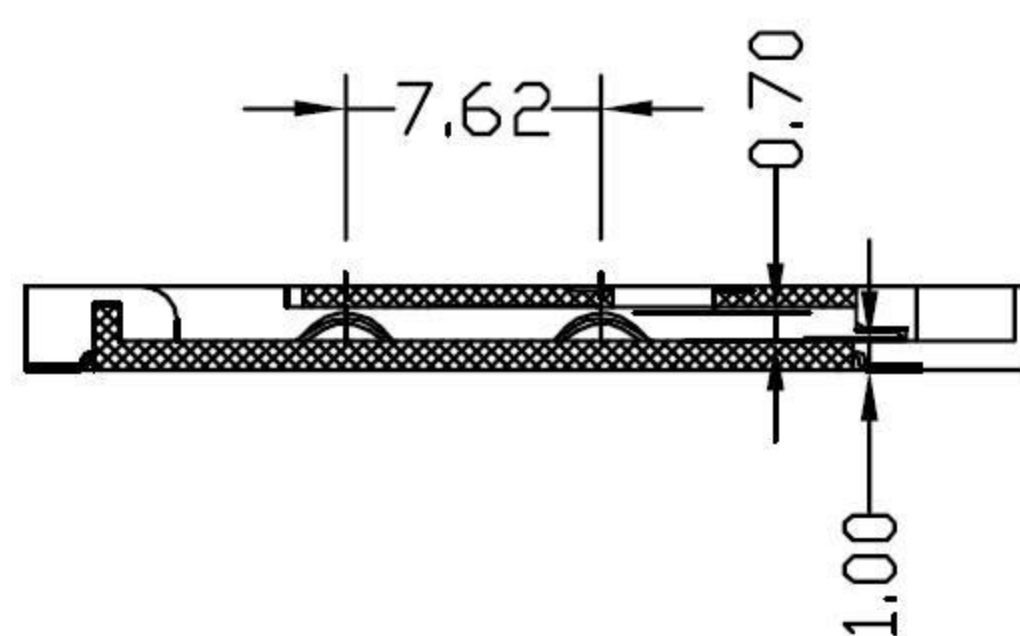
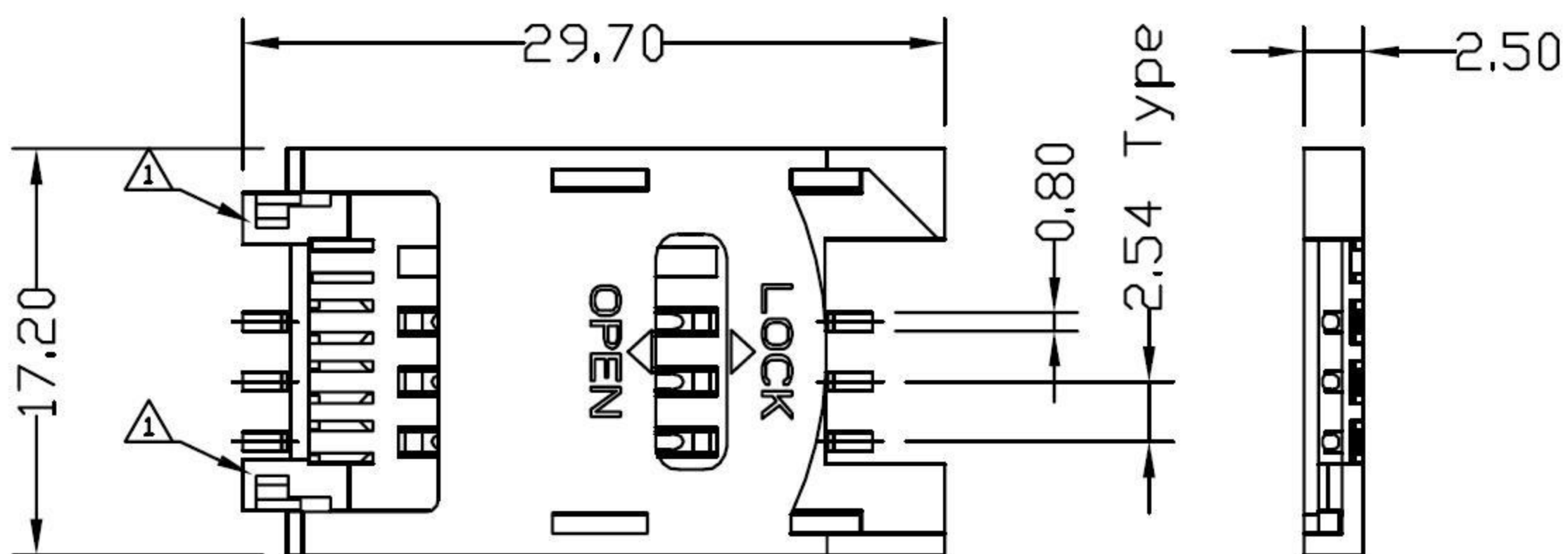




(.XX±0.05)

REFERENCE PCB LAYOUT

SPECIFICATIONS

Housing: Thermoplastic (UL94 V-0)

Terminal: Phosphor Bronze, Gold Plating On Contact Area,

Tin Plating On Solder Tail.

Current Rating: 0.5A Max.

Dielectric Withstanding Voltage: 500V AC R.M.S. For 1 Minute

Insulation Resistance: 1000 Megohms Min. At DC 500V

Contact Resistance: 50 Milliohms Max.

Durability: 5000 Cycles

Manual Soldering: 360°C, 3Sec Max.

Vapor Phase: 215°C, 30Sec Max.

IR Reflow: 260°C, 15Sec Max.

Operation Temperature: -25°C To +85°C

RoHS Compliant

HOW TO ORDER
ASM000-06DT

Special Options

	DIMENSION	mm	DATE	REVISION	APPROVAL BY
	DRAW BY	Joe			
	APPROVAL BY	Rikki			
	DATE				

DESCRIPTION: SIM Card Socket / Hinge-Type / 6 Pin / S.M.D